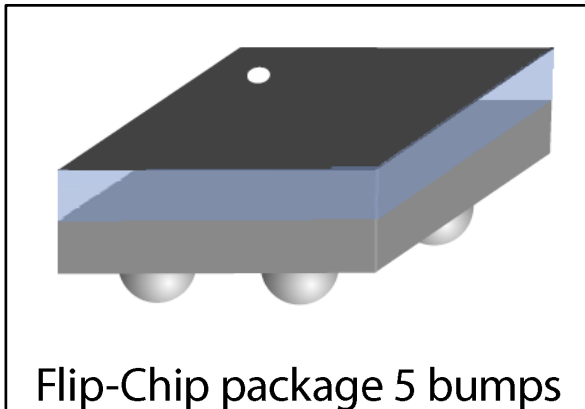


50  $\Omega$  nominal input / conjugate match balun CC2610, CC2620, CC2630, CC2640, CC2650 MHz, with integrated harmonic filter

Datasheet - production data



## Description

STMicroelectronics' BALF-CC26-05D3 is an ultra-miniature balun, integrating both matching network and harmonics filter.

Matching impedance has been customized for the TI CC26xx series 5x5 SimpleLink™ multistandard wireless MCU.

The device uses STMicroelectronics' IPD technology on a non-conductive glass substrate, which optimizes RF performance.

## Features

- 2.45 GHz balun with integrated matching network
- Matching optimized for CC26 series 5x5 external differential
- Low insertion loss
- Low amplitude imbalance
- Low phase imbalance
- Coated Flip-Chip on glass
- Small footprint < 1.5 mm<sup>2</sup>

## Benefits

- Very low profile
- High RF performance
- PCB space saving versus discrete solution
- RF BOM and size reduction
- Efficient manufacturability

Figure 1: Pin configuration

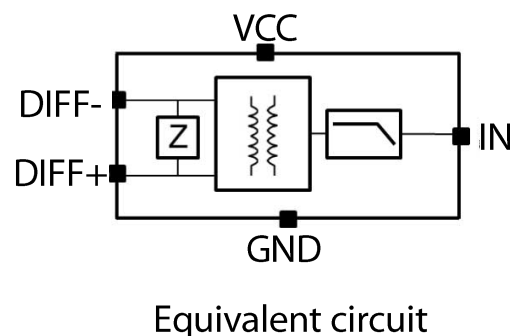
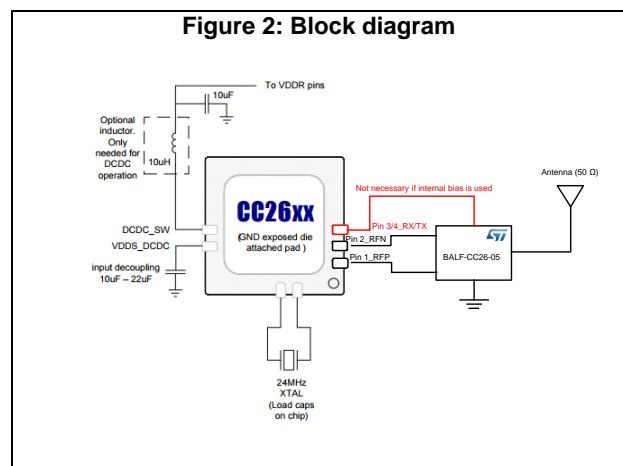


Figure 2: Block diagram



# 1 Characteristics

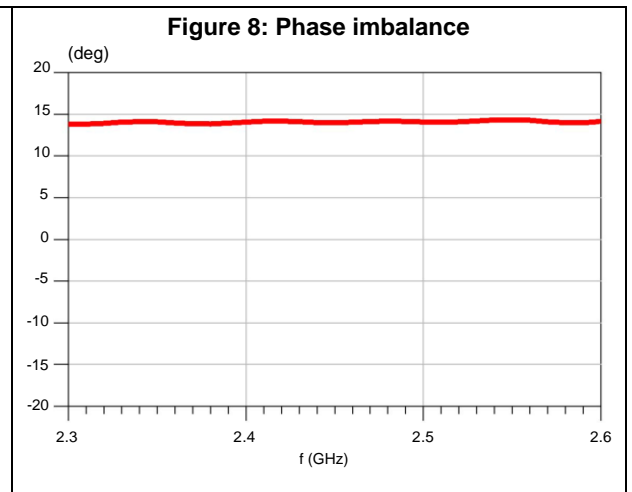
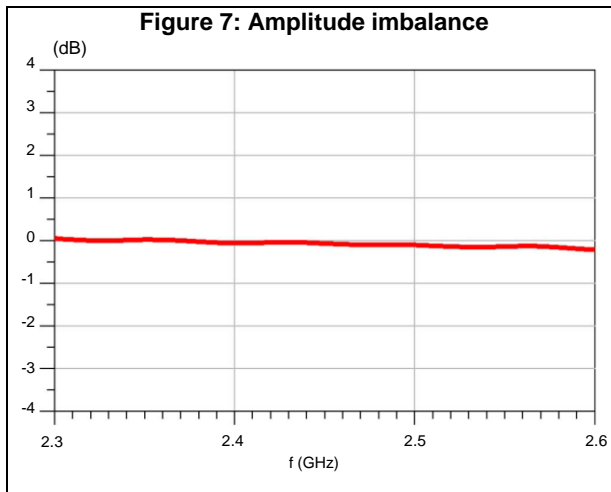
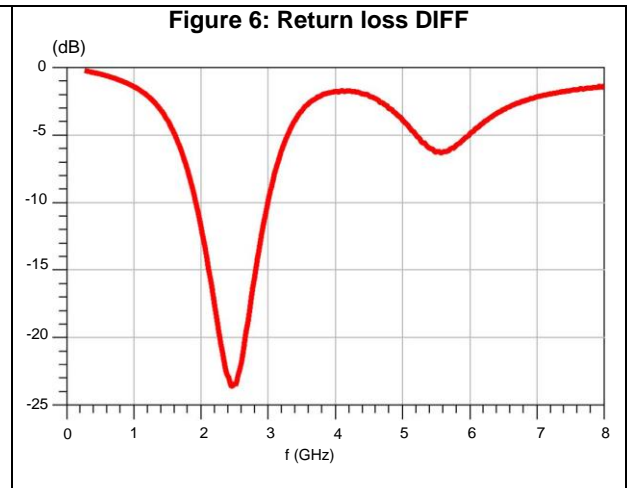
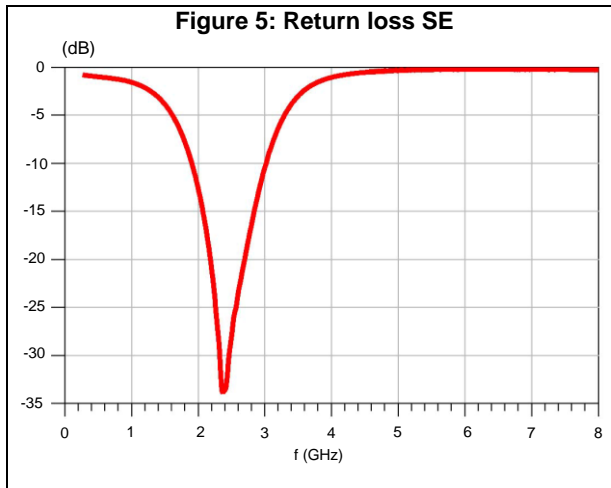
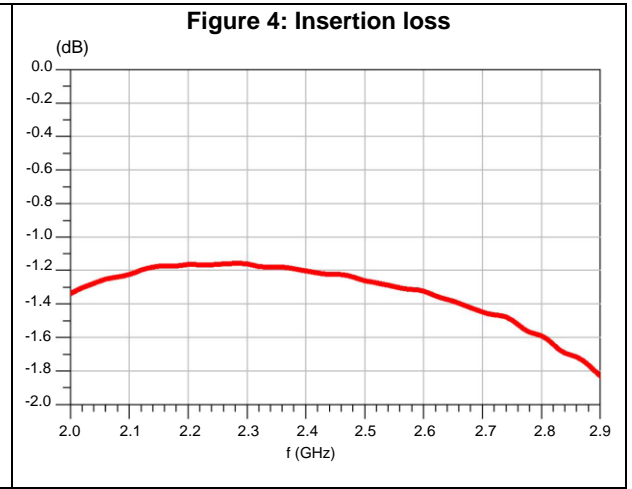
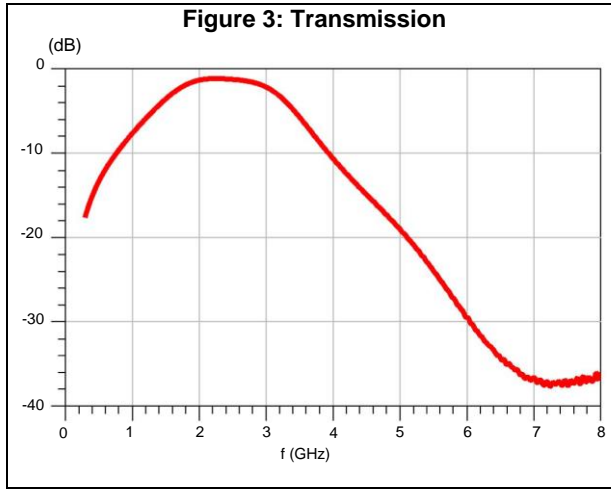
**Table 1: Absolute maximum ratings (limiting values)**

| Symbol           | Parameter   | Value       | Unit |
|------------------|---|-------------|------|
| P <sub>IN</sub>  | Input power RFIN  | 20          | dBm  |
| V <sub>ESD</sub> | ESD ratings MIL STD883C (HBM: C = 100 pF, R = 1.5 Ω, air discharge) | 900         | V    |
|                  | ESD ratings machine model (MM: C = 200 pF, R = 25 W, L = 500 nH)    | 100         |      |
| T <sub>OP</sub>  | Operating temperature   | -40 to +105 | °C   |

**Table 2: Electrical characteristics (T<sub>amb</sub> = 25 °C)**

| Symbol           | Parameter                             | Value                      |      |      | Unit |
|------------------|---------------------------------------|----------------------------|------|------|------|
|                  |                                       | Min.                       | Typ. | Max. |      |
| Z <sub>OUT</sub> | Nominal differential output impedance | Match to 5x5 CC26xx series |      |      | Ω    |
| Z <sub>IN</sub>  | Nominal input impedance               |                            | 50   |      | Ω    |
| f                | Frequency range (bandwidth)           | 2400                       |      | 2500 | MHz  |
| IL               | Insertion loss in bandwidth           |                            | 1.2  | 1.5  | dB   |
| RL SE            | Single Ended Return loss in bandwidth |                            | -27  | -18  | dB   |
| RL DIFF          | Differential Return loss in bandwidth |                            | -23  | -20  | dB   |
| Phase_imbal      | Phase imbalance                       | -16                        |      | 16   | °    |
| Ampl_imbal       | Amplitude imbalance                   | -0.3                       |      | 0.3  | dB   |
| H2               | Second harmonic rejection             |                            | -18  | -17  |      |
| H3               | Third harmonic rejection              |                            | -37  | -35  |      |

### 1.2 RF measurement

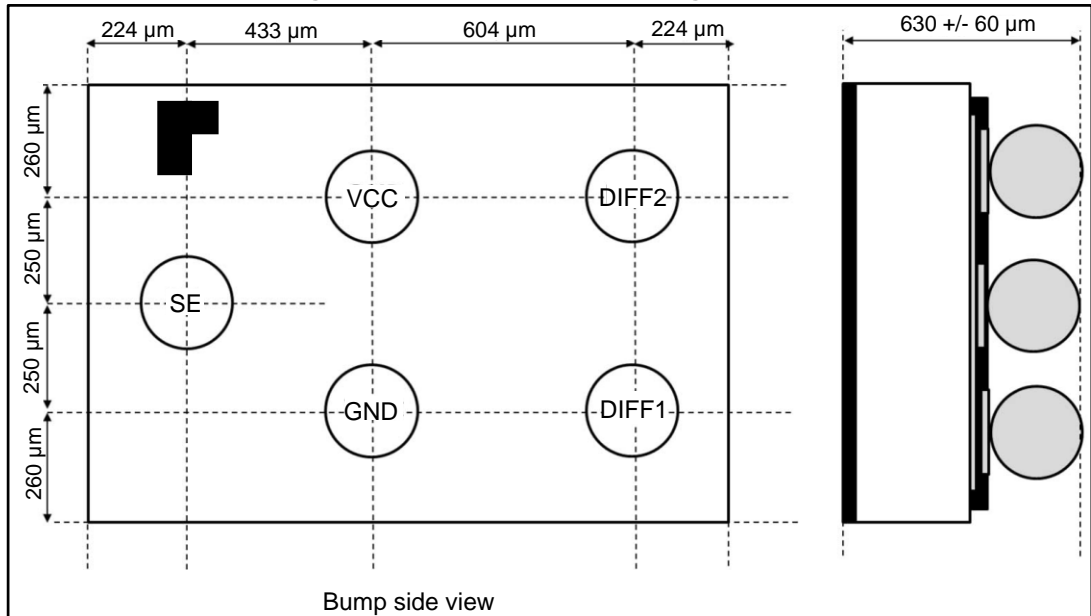


## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

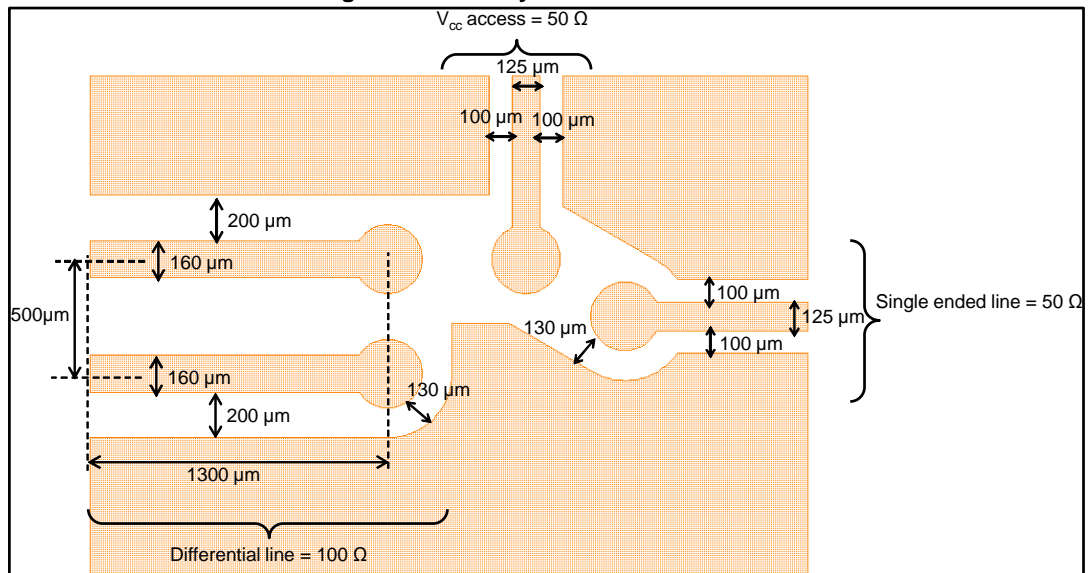
### 2.1 Flip-Chip CSPG 0.4 package information

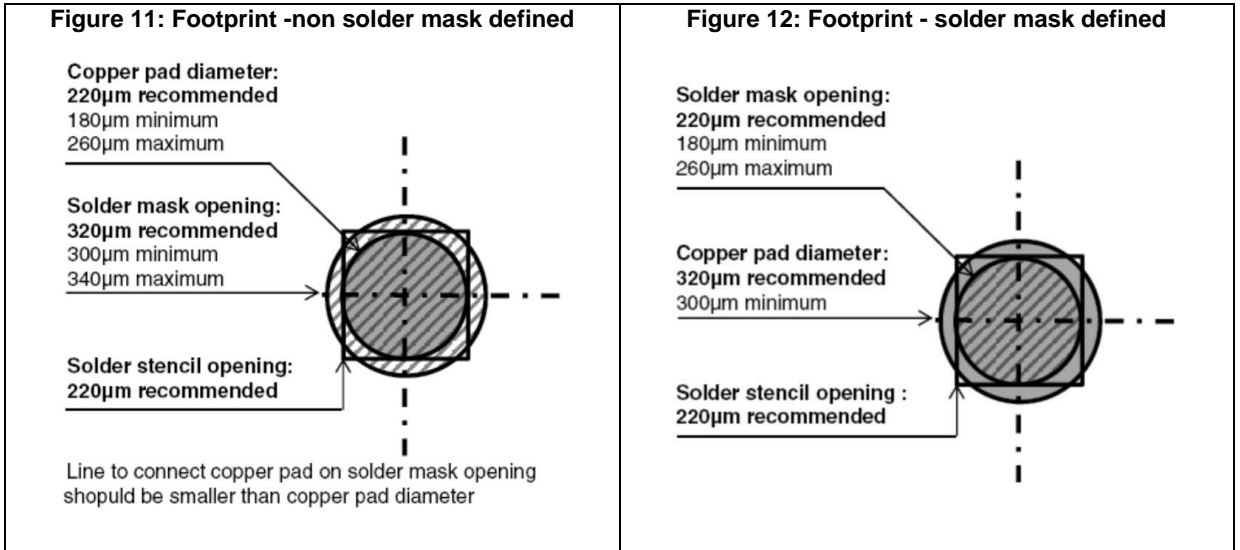
Figure 9: Flip-Chip CSPG 0.4 package outline



Bump side view

Figure 10: PCB layout recommendation





## 2.2 Flip-chip CSPG 0.4 packing information

Figure 13: Flip-chip CSPG 0.4 tape outline

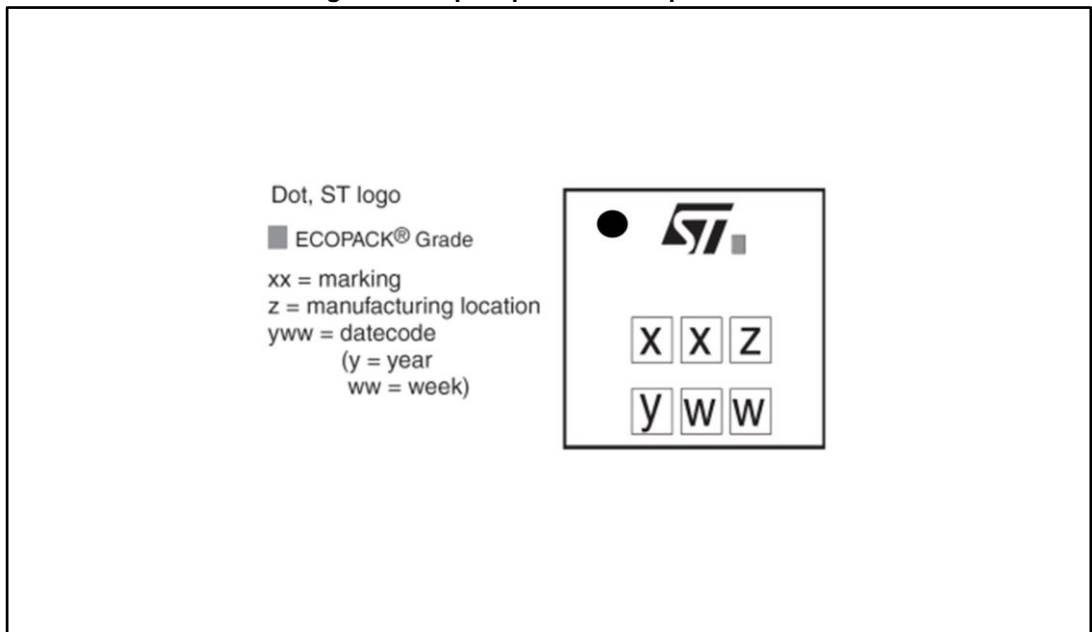
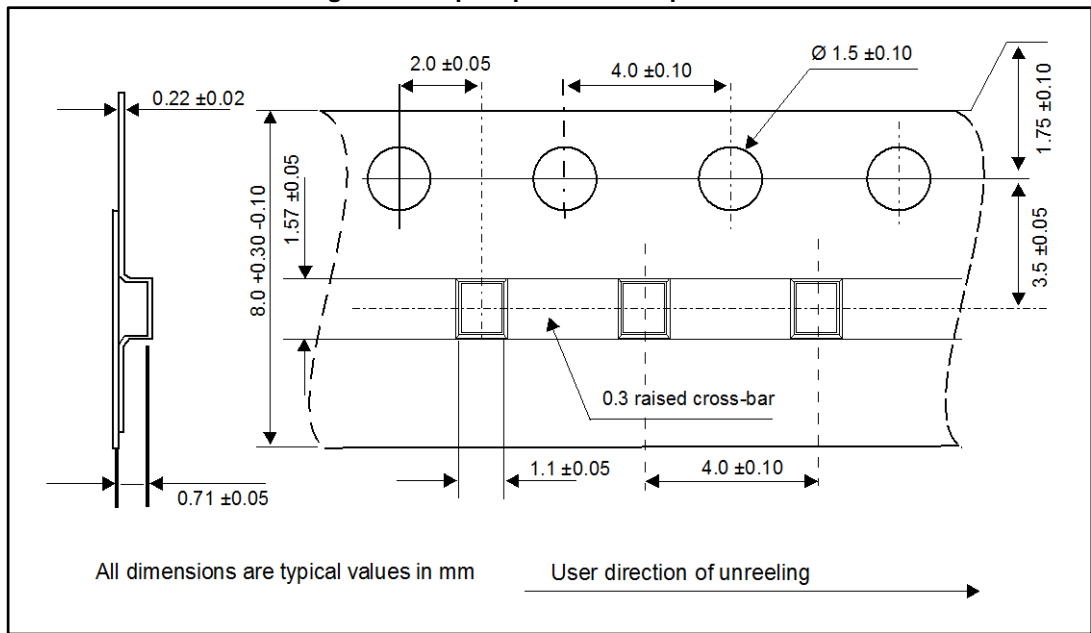


Figure 14: Flip-chip CSPG 0.4 tape outline



### 3 Ordering information

Table 3: Ordering information

| Order code     | Marking | Package            | Weight   | Base qty. | Delivery mode      |
|----------------|---------|--------------------|----------|-----------|--------------------|
| BALF-CC26-05D3 | TH      | Flip-Chip CSPG 0.4 | 1.724 mg | 5000      | Tape and reel (7") |

### 4 Revision history

Table 4: Document revision history

| Date        | Revision | Changes      |
|-------------|----------|--------------|
| 27-Jul-2016 | 1        | First issue. |

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